SN54246, SN54247, SN54LS247, SN54LS248
SN74246, SN74247, SN74LS247, SN74LS248
BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

MARCH 1974—REVISED MARCH 1988

'246, '247, 'LS247 feature

- Open-Collector Outputs Drive Indicators Directly
- Lamp-Test Provision
- Leading/Trailing Zero Suppression

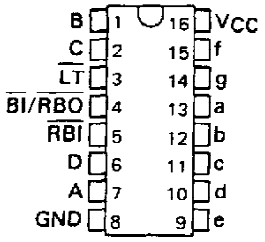
'LS248 feature

- Internal Pull-Ups Eliminate Need for External Resistors
- Lamp-Test Provision
- Leading/Trailing Zero Suppression

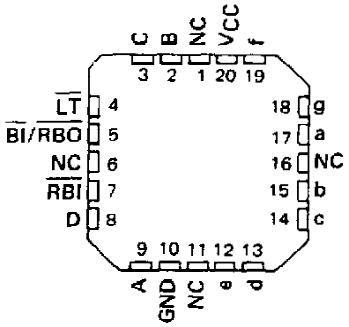
- All Circuit Types Feature Lamp Intensity Modulation Capability

TYPE	DRIVER OUTPUTS				TYPICAL POWER DISSIPATION	PACKAGES
	ACTIVE LEVEL	OUTPUT CONFIGURATION	SINK CURRENT	MAX VOLTAGE		
SN54246	low	open-collector	40 mA	30 V	320 mW	J,W
SN54247	low	open-collector	40 mA	15 V	320 mW	J,W
SN54LS247	low	open-collector	12 mA	15 V	35 mW	J,W
SN54LS248	high	2-kΩ pull-up	2 mA	5.5 V	125 mW	J,W
SN74246	low	open-collector	40 mA	30 V	320 mW	J,N
SN74247	low	open-collector	40 mA	15 V	320 mW	J,N
SN74LS247	low	open-collector	24 mA	15 V	35 mW	J,N
SN74LS248	high	2-kΩ pull-up	6 mA	5.5 V	125 mW	J,N

SN54246, SN54247 . . . J PACKAGE
SN54LS247 THRU SN54LS248 . . . J OR W PACKAGE
SN74246, SN74247 . . . N PACKAGE
SN74LS247, SN74LS248 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS247, SN54LS248 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

TEXAS INSTRUMENTS
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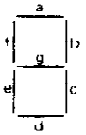
description

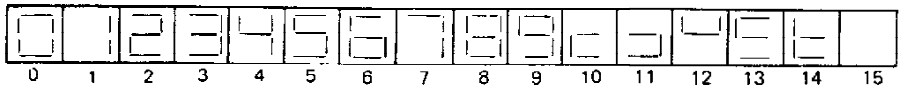
The '246 and '247 are electrically and functionally identical to the SN5446A/SN7446A, and SN5447A/SN7447A respectively, and have the same pin assignments as their equivalents. The 'LS247 and 'LS248 are electrically and functionally identical to the SN54LS47/SN74LS47 and SN54LS48/SN74LS48, respectively, and have the same pin assignments as their equivalents. They can be used interchangeably in present or future designs to offer designers a choice between two indicator fonts. The '46A, '47A, 'LS47, and 'LS48 compose the 6 and the 9 without tails and the '246, '247, 'LS247, and 'LS248 compose the 6 and the 9 with tails. Composition of all other characters, including display patterns for BCD inputs above nine, is identical. The '246, '247, and 'LS247 feature active-low outputs designed for driving indicators directly, and the 'LS248 features active-high outputs for driving lamp buffers. All of the circuits have full ripple-blanking input/output controls and a lamp test input. Segment identification and resultant displays are shown below. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions.

All of these circuits incorporate automatic leading and/or trailing-edge zero-blanking control ($\overline{RBI}$ and $\overline{RBO}$). Lamp test ($\overline{LT}$) of these types may be performed at any time when the $\overline{BI}/\overline{RBO}$ node is at a high level. All types contain an overriding blanking input (BI) which can be used to control the lamp intensity by pulsing or to inhibit the outputs. Inputs and outputs are entirely compatible for use with TTL logic outputs.

Series 54 and Series 54LS devices are characterized for operation over the full military temperature range of −55°C to 125°C; Series 74 and Series 74LS devices are characterized for operation from 0°C to 70°C.



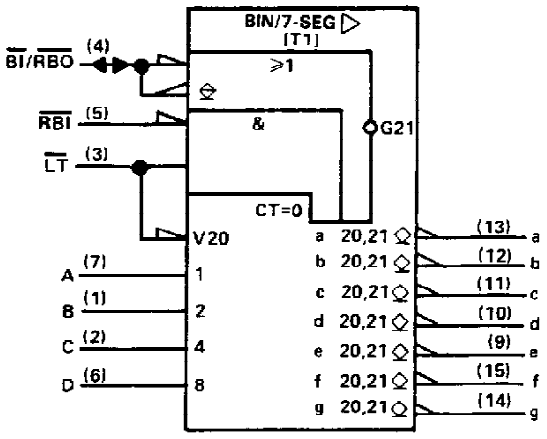
SEGMENT IDENTIFICATION



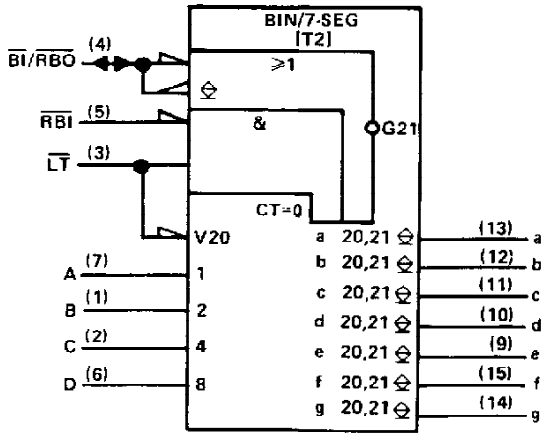
NUMERICAL DESIGNATIONS AND RESULTANT DISPLAYS

logic symbols†

'246, '247, 'LS247



'LS248



†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

'246, '247, 'LS247 FUNCTION TABLE (T1)

DECIMAL OR FUNCTION	INPUTS						$\overline{BI}/\overline{RBO}$†	OUTPUTS							NOTE
	LT	RBI	D	C	B	A		a	b	c	d	e	f	g	
0	H	H	L	L	L	L	H	ON	ON	ON	ON	ON	ON	OFF	
1	H	X	L	L	L	H	H	OFF	ON	ON	OFF	OFF	OFF	OFF	
2	H	X	L	L	H	L	H	ON	ON	OFF	ON	ON	OFF	ON	
3	H	X	L	L	H	H	H	ON	ON	ON	ON	OFF	OFF	ON	
4	H	X	L	H	L	L	H	OFF	ON	ON	OFF	OFF	ON	ON	
5	H	X	L	H	L	H	H	ON	OFF	ON	ON	OFF	ON	ON	
6	H	X	L	H	H	L	H	ON	OFF	ON	ON	ON	ON	ON	
7	H	X	L	H	H	H	H	ON	ON	ON	OFF	OFF	OFF	OFF	
8	H	X	H	L	L	L	H	ON	ON	ON	ON	ON	ON	ON	1
9	H	X	H	L	L	H	H	ON	ON	ON	ON	OFF	ON	ON	
10	H	X	H	L	H	L	H	OFF	OFF	OFF	ON	ON	OFF	ON	
11	H	X	H	L	H	H	H	OFF	OFF	ON	ON	OFF	OFF	ON	
12	H	X	H	H	L	L	H	OFF	ON	OFF	OFF	OFF	ON	ON	
13	H	X	H	H	L	H	H	ON	OFF	OFF	ON	OFF	ON	ON	
14	H	X	H	H	H	L	H	OFF	OFF	OFF	ON	ON	ON	ON	
15	H	X	H	H	H	H	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	
$\overline{BI}$	X	X	X	X	X	X	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	2
$\overline{RBI}$	H	L	L	L	L	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	3
$\overline{LT}$	L	X	X	X	X	X	H	ON	ON	ON	ON	ON	ON	ON	4

'LS248 FUNCTION TABLE (T2)

DECIMAL OR FUNCTION	INPUTS						$\overline{BI}/\overline{RBO}$†	OUTPUTS							NOTE
	$\overline{LT}$	$\overline{RBI}$	D	C	B	A		a	b	c	d	e	f	g	
0	H	H	L	L	L	L	H	H	H	H	H	H	H	L	
1	H	X	L	L	L	H	H	L	H	H	L	L	L	L	
2	H	X	L	L	H	L	H	H	H	L	H	H	L	H	
3	H	X	L	L	H	H	H	H	H	H	H	L	L	H	
4	H	X	L	H	L	L	H	L	H	H	L	L	H	H	
5	H	X	L	H	L	H	H	H	L	H	H	L	H	H	
6	H	X	L	H	H	L	H	H	L	H	H	H	H	H	
7	H	X	L	H	H	H	H	H	H	H	L	L	L	L	1
8	H	X	H	L	L	L	H	H	H	H	H	H	H	H	
9	H	X	H	L	L	H	H	H	H	H	H	L	H	H	
10	H	X	H	L	H	L	H	L	L	L	H	H	L	H	
11	H	X	H	L	H	H	H	L	L	H	H	L	L	H	
12	H	X	H	H	L	L	H	L	H	L	L	L	H	H	
13	H	X	H	H	L	H	H	H	L	L	H	L	H	H	
14	H	X	H	H	H	L	H	L	L	L	H	H	H	H	
15	H	X	H	H	H	H	H	L	L	L	L	L	L	L	
$\overline{BI}$	X	X	X	X	X	X	L	L	L	L	L	L	L	L	2
$\overline{RBI}$	H	L	L	L	L	L	L	L	L	L	L	L	L	L	3
$\overline{LT}$	L	X	X	X	X	X	H	H	H	H	H	H	H	H	4

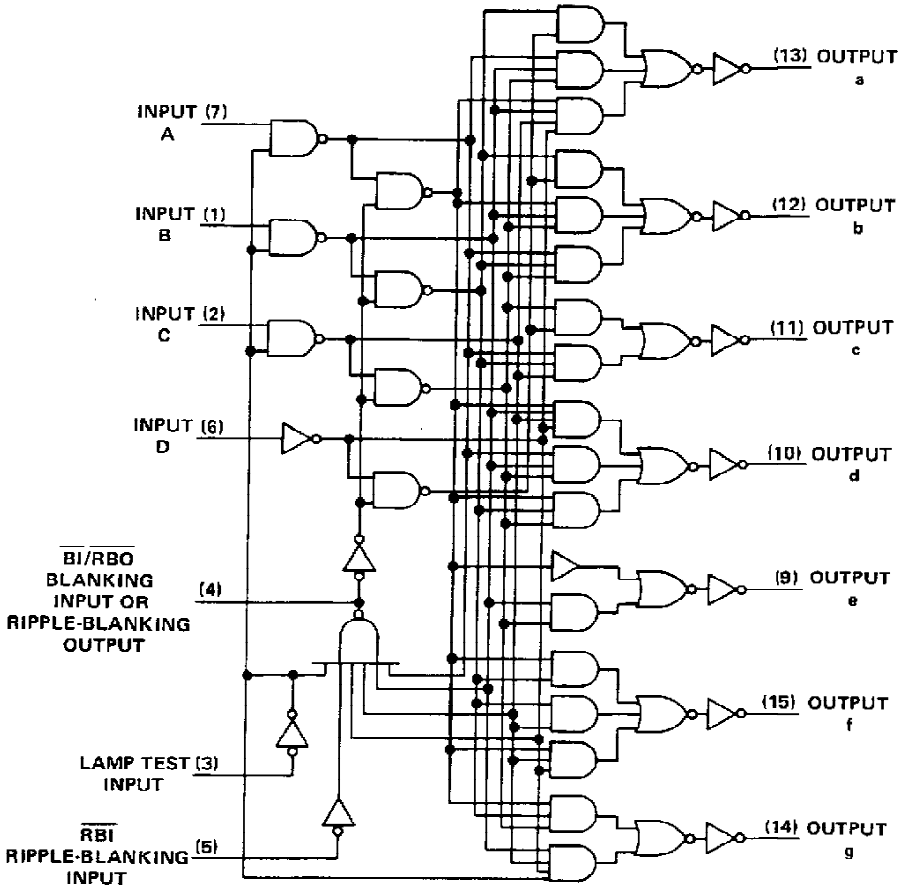
H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input ($\overline{BI}$) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input ($\overline{RBI}$) must be open or high if blanking of a decimal zero is not desired.
2. When a low logic level is applied directly to the blanking input ($\overline{BI}$), all segment outputs are low regardless of the level of any other input.
3. When ripple-blanking input ($\overline{RBI}$) and inputs A, B, C, and D are at a low level with the lamp test input high, all segment outputs go low and the ripple-blanking output ($\overline{RBO}$) goes to a low level (response condition).
4. When the blanking input/ripple-blanking output ($\overline{BI}/\overline{RBO}$) is open or held high and a low is applied to the lamp-test input, all segment outputs are high.

† $\overline{BI}/\overline{RBO}$ is wire-AND logic serving as blanking input ($\overline{BI}$) and/or ripple-blanking output ($\overline{RBO}$).

logic diagram (positive logic)

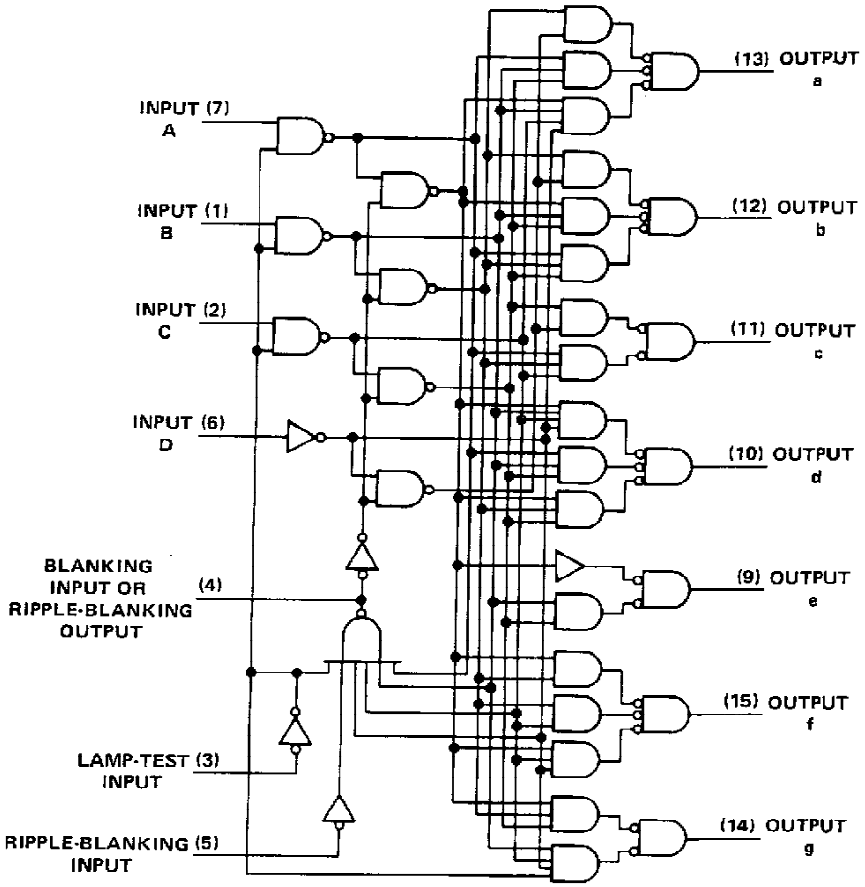
'246, '247, 'LS247



Pin numbers shown are for D, J, N, and W packages.

logic diagram (positive logic)

'LS248

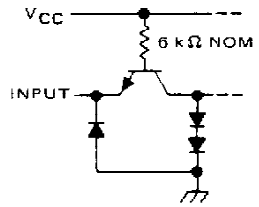


Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs

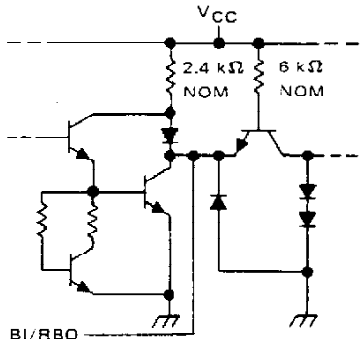
'246, '247

EQUIVALENT OF EACH INPUT EXCEPT $\overline{BI}/\overline{RBO}$



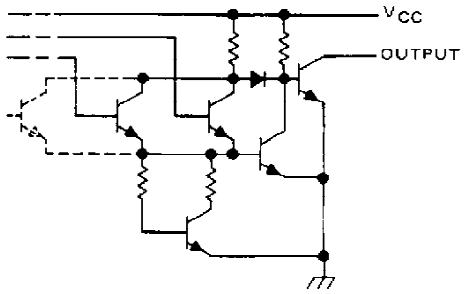
'246, '247

EQUIVALENT OF $\overline{BI}/\overline{RBO}$



'246, '247

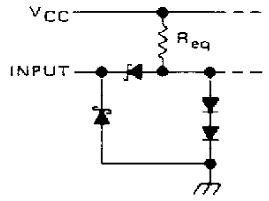
TYPICAL OF OUTPUTS a THRU g



schematics of inputs and outputs

'LS247, 'LS248

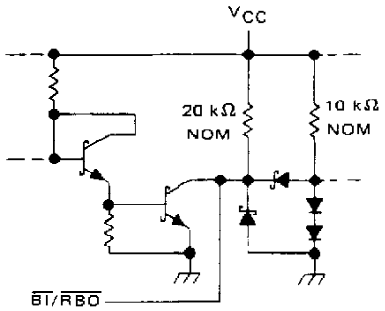
EQUIVALENT OF EACH INPUT EXCEPT $\overline{BI}/\overline{RBO}$



$\overline{LT}$ and $\overline{RBI}$: R_{eq} = 20 kΩ NOM
A, B, C, and D: R_{eq} = 25 kΩ NOM

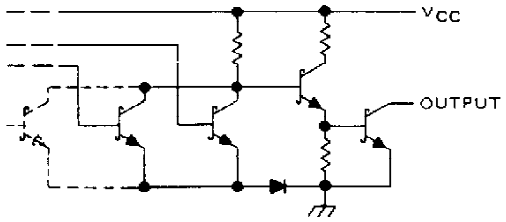
'LS247, 'LS248

EQUIVALENT OF $\overline{BI}/\overline{RBO}$



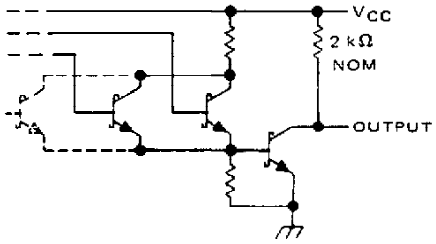
'LS247

TYPICAL OF OUTPUTS a THRU g



'LS248

TYPICAL OF OUTPUTS a THRU g



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Current forced into any output in the off state . . . . . 1 mA
Operating free-air temperature range: SN54246, SN54247 . . . . . −55°C to 125°C
SN74246, SN74247 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54246			SN54247			SN74246			SN74247			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.5	5	5.5	4.75	5	5.25	4.75	5	5.25	V
Off-state output voltage, $V_{O(off)}$	a thru g			30			15			30			15	V
On-state output current, $I_{O(on)}$	a thru g			40			40			40			40	mA
High-level output current, I_{OH}	$\overline{BI}/\overline{RBO}$			−200			−200			−200			−200	μA
Low-level output current, I_{OL}	$\overline{BI}/\overline{RBO}$			8			8			8			8	mA
Operating free-air temperature, T_A		−55		125	−55		125	0		70	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V_{IH}	High-level input voltage			2			V
V_{IL}	Low-level input voltage					0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = −12 mA			1.5 V	V
V_{OH}	High-level output voltage	$\overline{BI}/\overline{RBO}$	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −200 μA	2.4	3.7		V
V_{OL}	Low-level output voltage	$\overline{BI}/\overline{RBO}$	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 8 mA		0.27	0.4	V
$I_{O(off)}$	Off-state output current	a thru g	V_{CC} = MAX, V_{IH} = 2 V, V_{IL} = 0.8 V, $V_{O(off)}$ = MAX			250	μA
$V_{O(on)}$	On-state output voltage	a thru g	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, $I_{O(on)}$ = 40 mA		0.3	0.4	V
I_I	Input current at maximum input voltage	Any input except $\overline{BI}/\overline{RBO}$	V_{CC} = MAX, V_I = 5.5 V			1	mA
I_{IH}	High-level input current	Any input except $\overline{BI}/\overline{RBO}$	V_{CC} = MAX, V_I = 2.4 V			40	μA
I_{IL}	Low-level input current	Any input except $\overline{BI}/\overline{RBO}$	V_{CC} = MAX, V_I = 0.4 V			−1.6	mA
		$\overline{BI}/\overline{RBO}$				−4	
I_{OS}	Short-circuit output current	$\overline{BI}/\overline{RBO}$	V_{CC} = MAX			−4	mA
I_{CC}	Supply current		V_{CC} = MAX, See Note 2		64	103	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{off}	Turn-off time from A input	C_L = 15 pF, R_L = 120 Ω, See Note 3			100	ns
t_{on}	Turn-on time from A input				100	
t_{off}	Turn-off time from $\overline{RBI}$ input				100	ns
t_{on}	Turn-on time from $\overline{RBI}$ input				100	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Peak output current ($t_w \leq 1$ ms, duty cycle $\leq 10\%$) . . . . . 200 mA
Current forced into any output in the off state . . . . . 1 mA
Operating free-air temperature range: SN54LS247 . . . . . −55°C to 125°C
SN74LS247 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS247			SN74LS247			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5	5	5.5	4.75	5	5.25	V
Off-state output voltage, $V_{O(off)}$	a thru g			15			15	V
On-state output current, $I_{O(on)}$	a thru g			12			24	mA
High-level output current, I_{OH}	$\overline{BI}/\overline{RBO}$			−50			−50	μA
Low-level output current, I_{OL}	$\overline{BI}/\overline{RBO}$			1.6			3.2	mA
Operating free-air temperature, T_A		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS247			SN74LS247			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	$\overline{BI}/\overline{RBO}$	V_{CC} = MIN, V_{IL} = V_{IL} max,	V_{IH} = 2 V, I_{OH} = −50 μA	2.4	4.2		2.4	4.2		V
V_{OL}	Low-level output voltage	$\overline{BI}/\overline{RBO}$	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 1.6 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 3.2 mA					0.35	0.5	
$I_{O(off)}$	Off-state output current	a thru g	V_{CC} = MAX, V_{IL} = V_{IL} max,	V_{IH} = 2 V, $V_{O(off)}$ = 15 V			250			250	μA
$V_{O(on)}$	On-state output voltage	a thru g	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	$I_{O(on)}$ = 12 mA		0.25	0.4		0.25	0.4	V
				$I_{O(on)}$ = 24 mA					0.35	0.5	
I_I	Input current at maximum input voltage		V_{CC} = MAX,	V_I = 7 V			0.1			0.1	mA
I_{IH}	High-level input current		V_{CC} = MAX,	V_I = 2.7 V			20			20	μA
I_{IL}	Low-level input current	Any input except $\overline{BI}/\overline{RBO}$	V_{CC} = MAX,	V_I = 0.4 V			−0.4			−0.4	mA
		$\overline{BI}/\overline{RBO}$					−1.2			−1.2	
I_{OS}	Short-circuit output current	$\overline{BI}/\overline{RBO}$	V_{CC} = MAX		−0.3		−2	−0.3		−2	mA
I_{CC}	Supply current		V_{CC} = MAX,	See Note 2		7	13		7	13	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
NOTE 2: I_{CC} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{off}	Turn-off time from A input	C_L = 15 pF, R_L = 665 Ω, See Note 3			100	ns
t_{on}	Turn-on time from A input				100	
t_{off}	Turn-off time from $\overline{RBI}$ input				100	ns
t_{on}	Turn-on time from $\overline{RBI}$ input				100	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74LS247D	Obsolete	Production	SOIC (D) | 16	-	-	Call TI	Call TI	0 to 70	LS247
SN74LS247DR	Active	Production	SOIC (D) | 16	2500 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS247
SN74LS247DR.A	Active	Production	SOIC (D) | 16	2500 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS247
SN74LS247N	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS247N
SN74LS247N.A	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS247N
SN74LS247NE4	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS247N
SN74LS247NSR	Active	Production	SOP (NS) | 16	2000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS247
SN74LS247NSR.A	Active	Production	SOP (NS) | 16	2000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS247

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

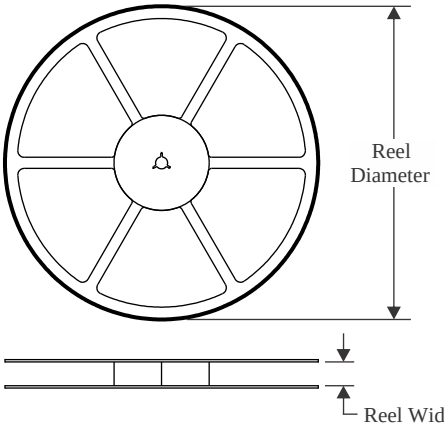
(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

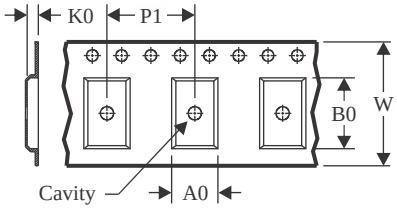
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

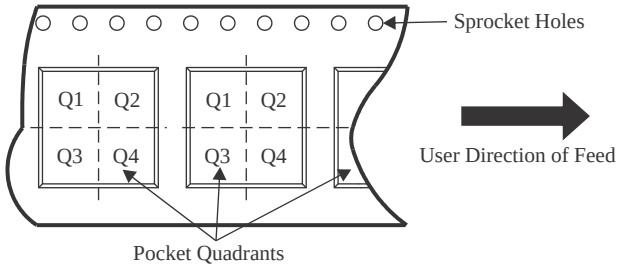


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

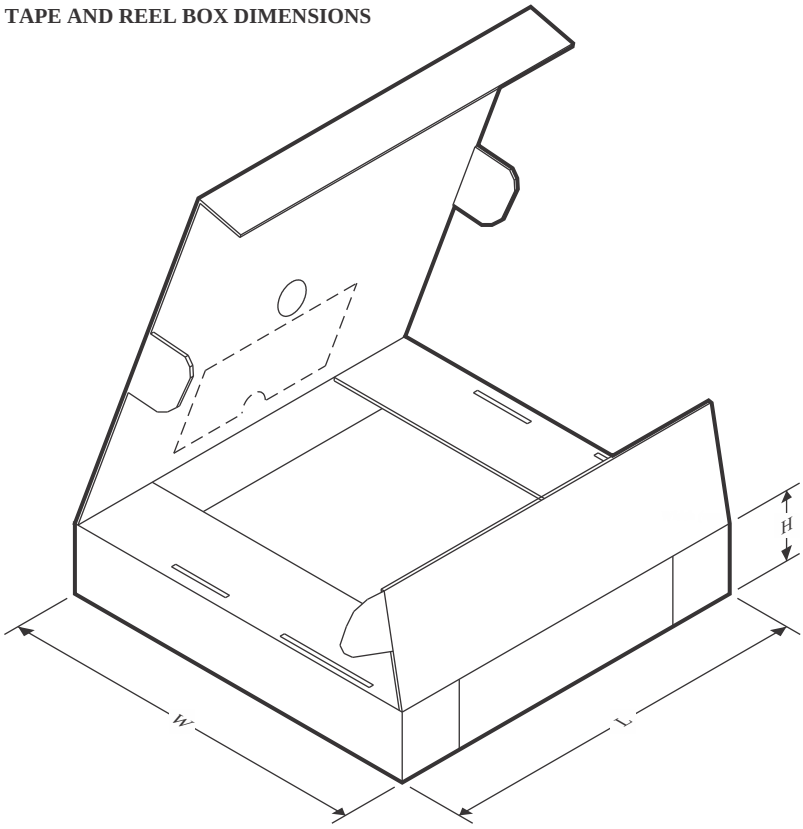
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS247DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS247NSR	SOP	NS	16	2000	330.0	16.4	8.45	10.55	2.5	12.0	16.2	Q1

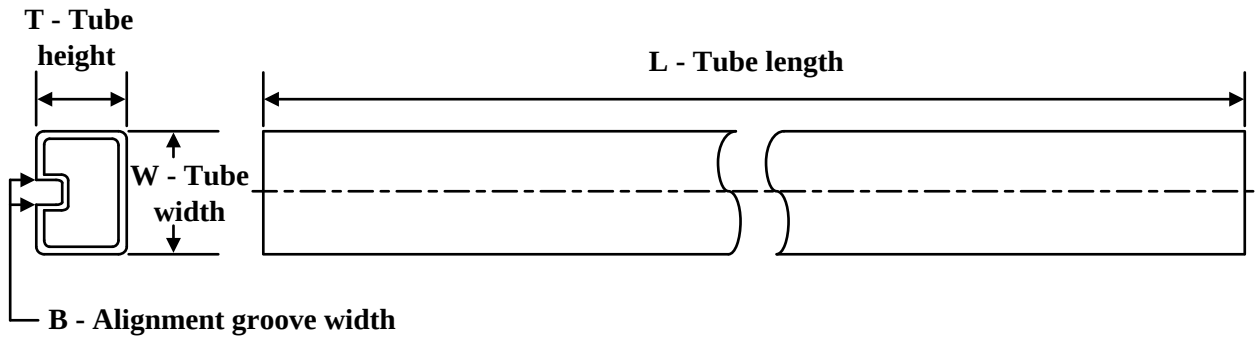
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

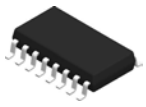
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS247DR	SOIC	D	16	2500	353.0	353.0	32.0
SN74LS247NSR	SOP	NS	16	2000	353.0	353.0	32.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74LS247N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS247N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS247N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS247N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS247NE4	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS247NE4	N	PDIP	16	25	506	13.97	11230	4.32

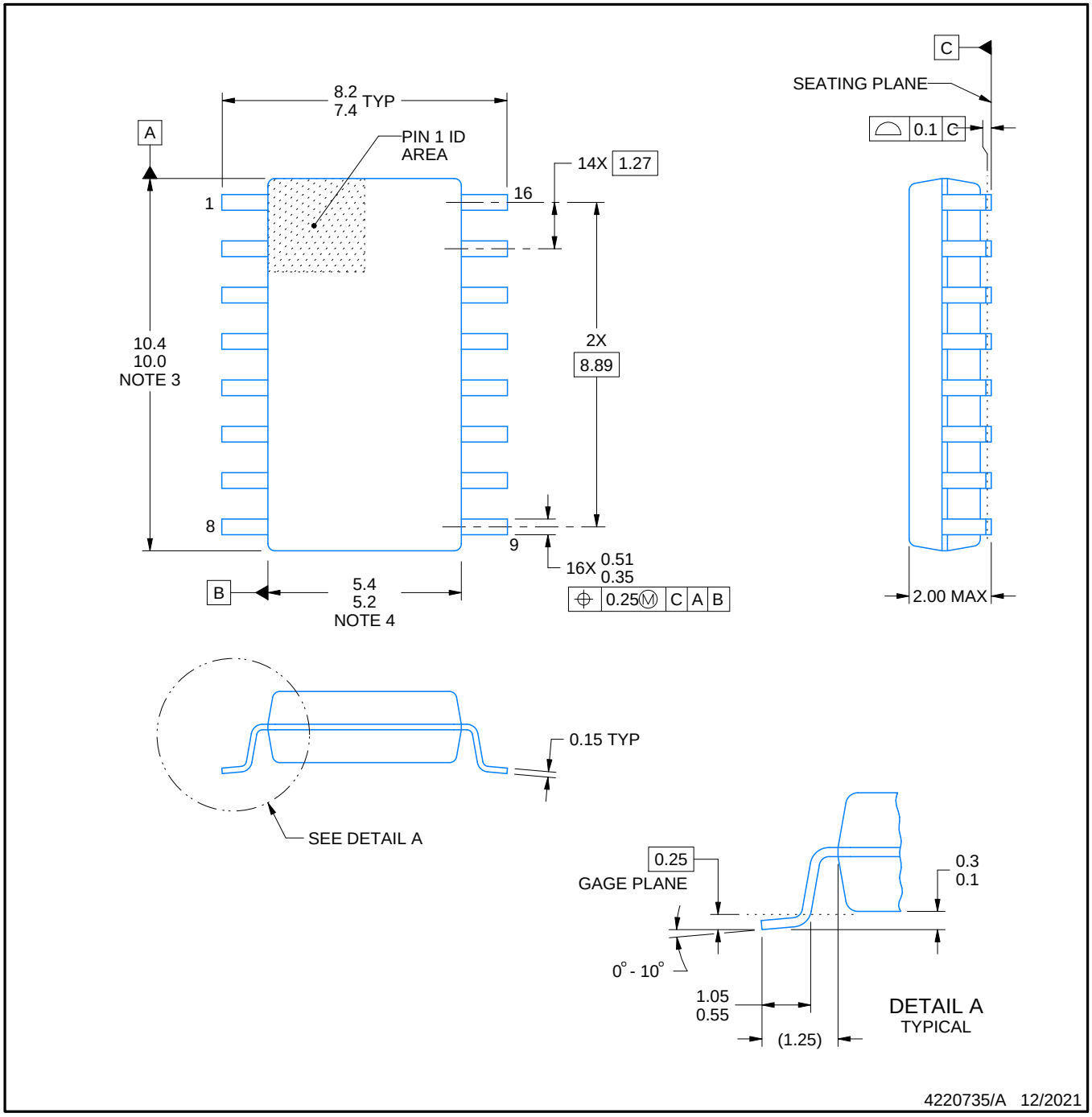


PACKAGE OUTLINE

NS0016A

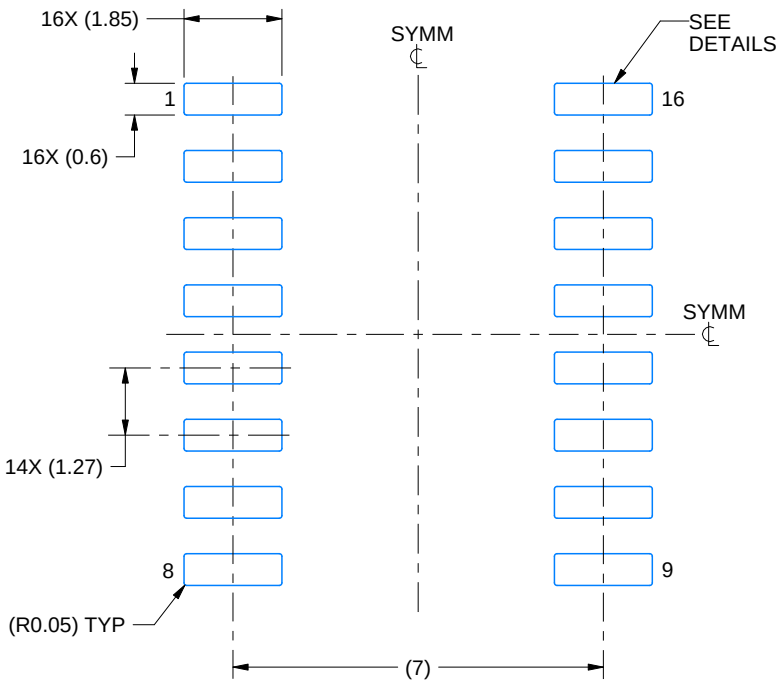
SOP - 2.00 mm max height

SOP

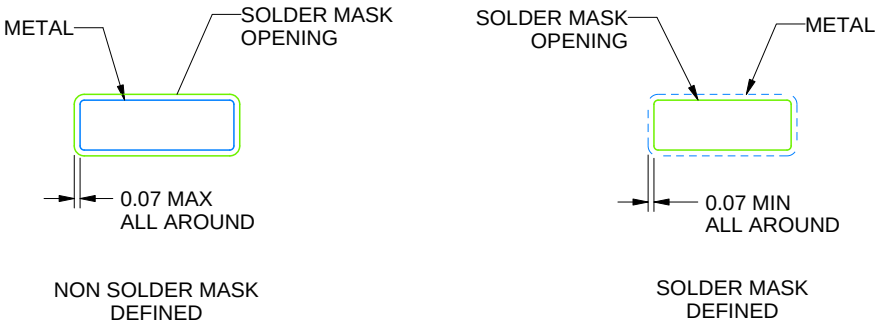


NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



LAND PATTERN EXAMPLE
SCALE:7X



NON SOLDER MASK
DEFINED

SOLDER MASK
DEFINED

SOLDER MASK DETAILS

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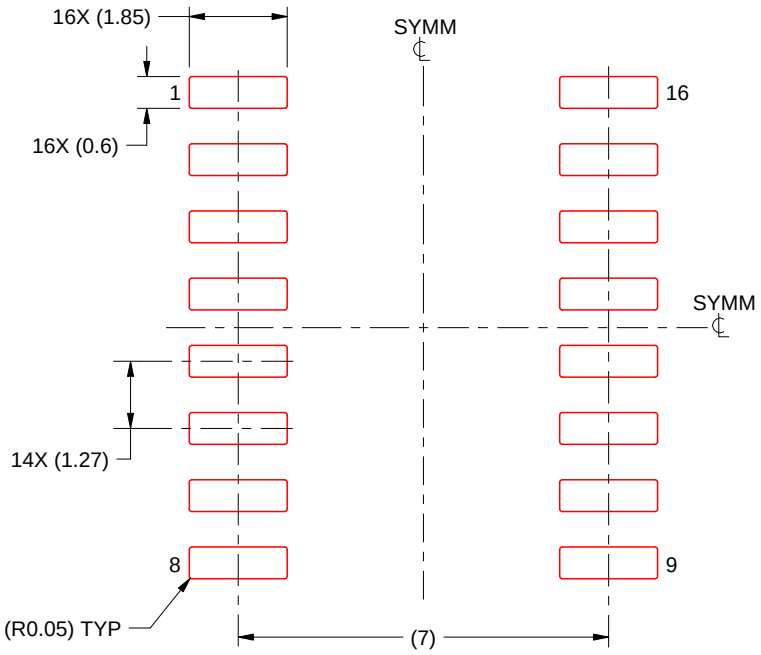
NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

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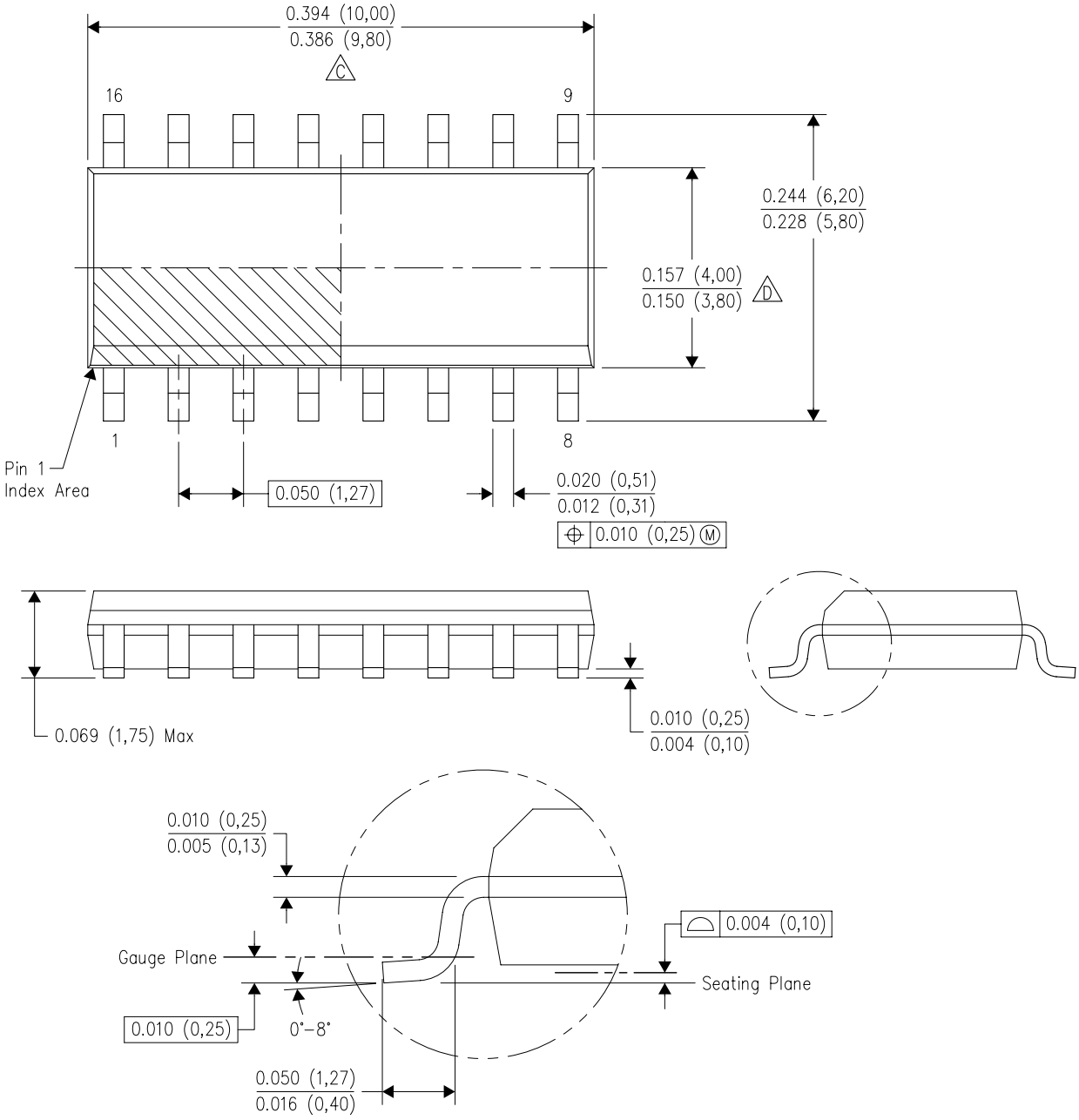
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R–PDSO–G16) PLASTIC SMALL OUTLINE

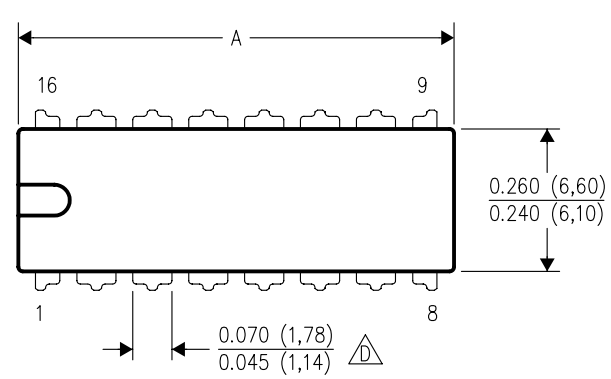


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AC.

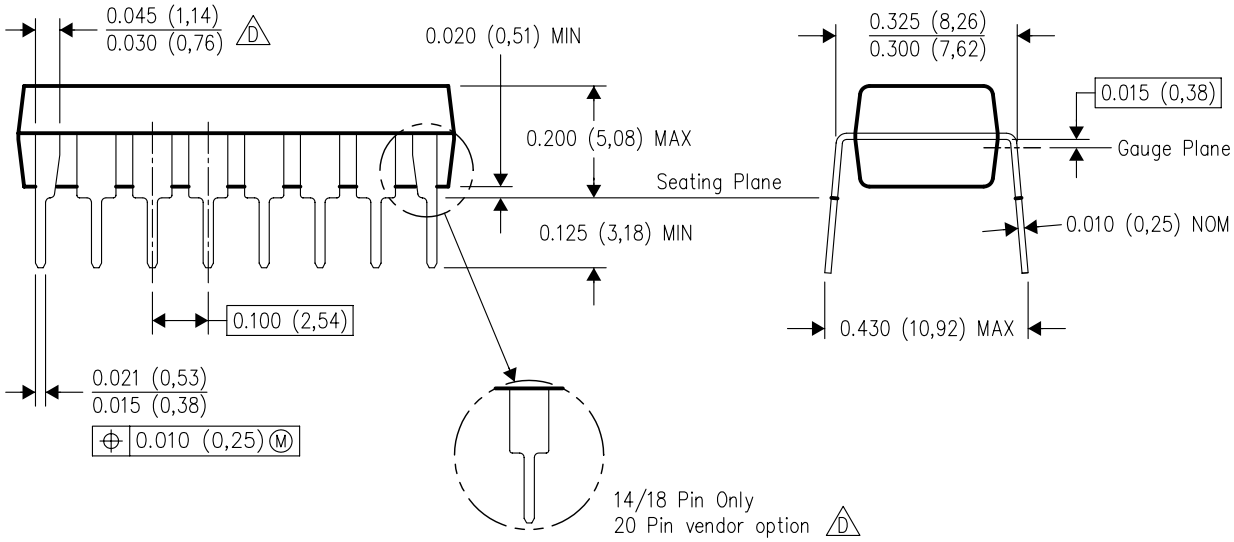
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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